

**U.S. Department of the Treasury**

**Outbound Investment Security Program**

Blank Notification Template for

§ 850.401 Undertaking a Notifiable Transaction

# U.S. Department of the Treasury

## Outbound Investment Security Program

### U.S. Person Information

Full Name:

Principal Place of Business [City]:

Principal Place of Business [Country]:

Place of Incorporation:

Primary NAICS Code:

Please provide a brief description of the U.S. Person:

Website Address (if any):

U.S. Person Ultimate Parent(s):

Type	Name	Principal Place of Business	Place of Incorporation
Entity/Individual			
Entity/Individual			
Entity/Individual			

Does the Ultimate Parent have any Intermediate Parent(s)?

Intermediate Parent(s):

Entity Name	Principal Place of Business	Place of Incorporation

**U.S. Company Address**

Street Address:

City:

State:

Zip Code:

Additional Information:

**Covered Transaction**

Briefly describe the commercial rationale for the transaction:

Provide a brief description of why the U.S. person has determined the transaction is a covered transaction that includes an explanation of the nature of the transaction, its structure, reference to the paragraph of § 850.210(a) that best describes the transaction type, and whether the notification is being submitted pursuant to § 850.401, § 850.402, or § 850.403:

Provide the actual date of the completed transaction:

Please provide an explanation of the status of the transaction:

Total transaction value (in U.S. dollars):

Please provide an explanation of how the transaction value was determined:

Provide the consideration (including cash, securities, other assets, and debt forgiveness) for the transaction:

Pre-transaction equity interest percentage:

Post-transaction equity interest percentage:

Provide the aggregate equity interest, voting interest, board seat (or equivalent holdings) of the U.S. person and its affiliates in the covered foreign person (or in the joint venture, as applicable) following the completion date of the transaction:

Was the transaction undertaken directly or indirectly? Yes/No

### **Agreements or Future Investments**

Are there any agreements or options for future investments not discussed above? Yes/No

If yes, please include a description of any agreements or commitments for future investment or options to make future investments in the covered foreign person (or joint venture):

### **Select the type of transaction undertaken:**

- Equity Interest (select one):
  - Majority
  - Minority
  - Full Acquisition
- Contingent Equity Interest
- Conversion of Equity Interest
- Debt Financing

- Assets (select all that apply):
  - Acquisition
  - Leasing
  - Development
- Joint Venture
- Acquisition of Interest in a Fund

### **Prior Transactions**

Is the transaction identified in this notification related to a prior transaction (e.g., between similar parties, acquiring additional interests, etc.)? Yes/No

If yes, please provide the related Notification ID, if applicable:

Has any party to this notification ever submitted a prior notification to the U.S. Department of the Treasury? Yes/No

If yes, please provide the relevant Notification ID, if applicable:

Additional information:

### **Covered Foreign Person**

Please select all Countries of Concern related to the Covered Foreign Person (select all that apply):

- People's Republic of China
- Hong Kong SAR
- Macau SAR

Full Name:

Principal Place of Business [City]:

Principal Place of Business [Country]:

Place of Incorporation or Legal Organization:

Is this individual a person of a country of concern?

Website Address (if any):

Please include a statement identifying and describing the attributes that cause the entity to be a covered foreign person, and any other relevant information regarding the covered foreign person and covered activity or activities:

## **Covered Foreign Person Company Address**

Street Address:

City:

Country:

Postal Code:

Does the Covered Foreign Person have any Intermediate Parents?

Intermediate Parent(s)

Entity Name	Principal Place of Business	Place of Incorporation

## Corporate Leadership

Please provide the full legal names and titles of each officer, director, and other members of management of the covered foreign person:

Title/Position	First Name	Middle Name	Last Name

## **Covered Activity**

### **Select all the Technology Activities that apply:**

- AI System                       Integrated Circuits & Equipment                       Quantum Technologies

#### **AI System Option(s):**

- |  |  |
|--|--|
| <input type="checkbox"/> AI system designed exclusively for or intended to be used for military, government intelligence, or mass surveillance end use                 | <input type="checkbox"/> AI system trained using a quantity of computing power greater than $10^{25}$ computational operations       |
| <input type="checkbox"/> AI system trained using a quantity of computer power greater than $10^{24}$ computational operations using primarily biological sequence data | <input type="checkbox"/> Other AI system trained using a quantity of computing power greater than $10^{23}$ computational operations |
| <input type="checkbox"/> Other AI system designed to be used for government intelligence or mass-surveillance end use  | <input type="checkbox"/> Other AI system intended to be used for cybersecurity applications  |
| <input type="checkbox"/> Other AI system intended to be used for digital forensics tools   | <input type="checkbox"/> Other AI systems intended to be used for penetration testing tools  |
| <input type="checkbox"/> Other AI systems intended to be used for the control of robotic systems   |  |

#### **Integrated Circuit & Equipment Option(s):**

- Integrated Circuits
- Integrated circuit meeting or exceeding performance parameters in ECCN 3A090.a, or designed for operation at or below 4.5 Kelvin
  - Logic integrated circuits (using a non-planar transistor architecture or with a production technology node of 16/14 nanometers or less)

- NAND memory integrated circuits (at least 128 layers)
- DRAM integrated circuits (technology node of 18 nanometer half-pitch or less)
- ICs manufactured from gallium-based semiconductor
- ICs using graphene transistors or nanotubes
- ICs designed for operation at or below 4.5 Kelvin
- IC Equipment
  - Front-end semiconductor fabrication equipment designed for performing volume fabrication of integrated circuits
  - Commodity, material, software, or technology designed exclusively for use in/with extreme ultraviolet lithography fabrication equipment
  - Supercomputer enabled by advanced integrated circuits with certain levels of processing power
- IC Design
  - Electronic design automation software for design of integrated circuits or advanced packaging
  - Other IC Design
- IC Fabrication
- IC Packaging
  - Equipment for performing volume advanced packaging
  - Advanced packaging techniques used to package any IC
  - Other IC Packaging

**Quantum Technologies Option(s):**

- Quantum Computers
- Critical components required to produce a quantum computer
- Quantum computers product designed or intended to be used for any military, government intelligence, or mass-surveillance end use
  - Quantum Computers Sensing
  - Quantum Computers Network
  - Quantum Computers Communication

- Quantum computers product designed or intended to be used for networking to scale up capabilities of quantum computers
  - Quantum Computers Network
  - Quantum Computers Communication
- Quantum Computers Product designed or intended to be used for secure communications
  - Quantum Computers Network
  - Quantum Computers Communication

Please identify and describe each of the covered activity or activities undertaken by the covered foreign person that makes the transaction a covered transaction:

Please describe the known end use(s) and end user(s) of the covered foreign person's technology, products, or services:

If a transaction involves a covered activity identified in § 850.217(a), (b), or (c), identification of the technology node(s) at which any applicable product is produced: